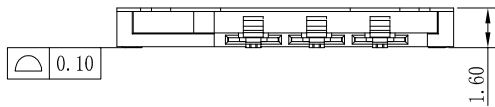
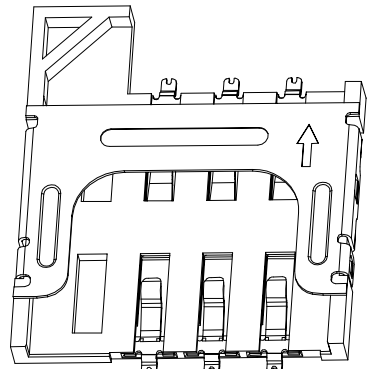
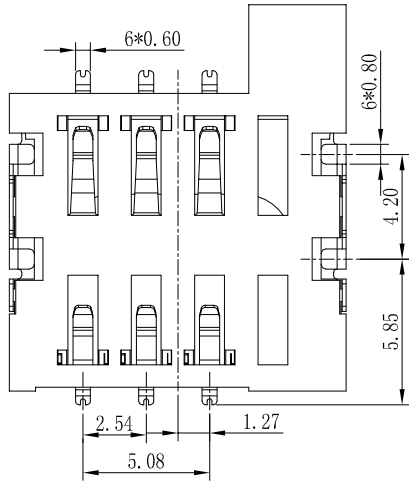
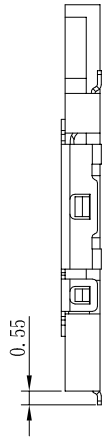
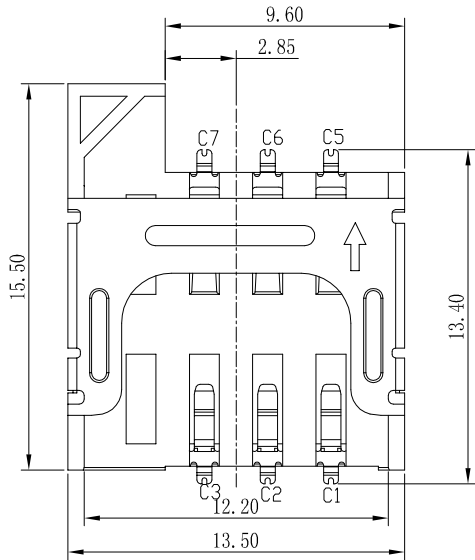


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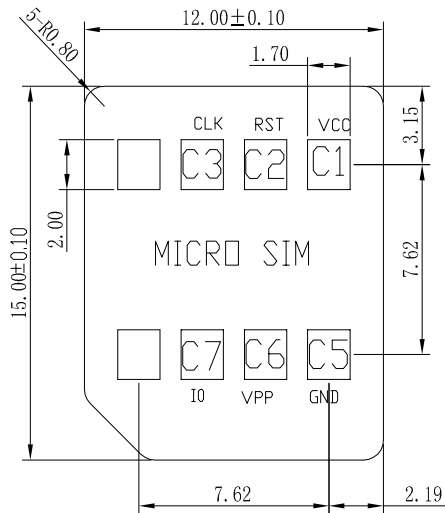
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REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2014/04/29



SIM Card Pin Assignment

Pin No.	Name
C1	Vcc
C2	RST
C3	CLK
C4	Rrserved
C5	GND
C6	Vpp
C7	I/O
C8	Reserved



NOTES:

1. MATERIAL:

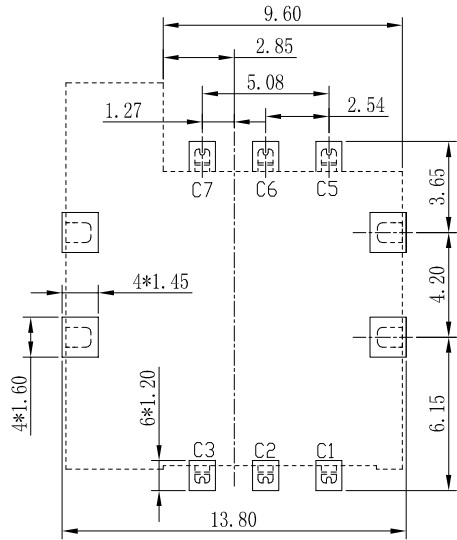
- 1). HOUSING MATERIAL: THERMOPLASTIC UL94V-0; COLOR: BLACK
- 2). CONTACT MATERIAL: COPPER ALLOY, T=0.15mm
- 3). SHELL MATERIAL: STAINLESS STEEL, T=0.15mm

2. FINISH:

- 1). CONTACT FINISH: 50u" MIN. NICKEL UNDER PLATED, PLATED 1u" Au ON CONTACT AREA : PLATED GOLD FLASH ON SOLDER AREA.
- 2). SHELL FINISH: 50u" MIN. NICKEL UNDER PLATED, PLATED GOLD FLASH ON SOLDER AREA.

3. ELECTRICAL SPECIFICATIONS:

- 1). VOLTAGE RATING: 12 VAC
- 2). CURRENT: 1 AMPERES MAX. PER CONTACT
- 3). OPERATION TEMPERATURE RANGE: -25℃ ~ +70℃
- 4). CONTACT RESISTANCE: 60MΩ MAX.
- 5). INSULATION RESISTANCE: 1000MΩ MIN.
- 6). DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE
- 7). MAX. PROCESSING TEMP: 260℃ for 30 SECONDS



PCB LAYOUT
TOLERANCE: ±0.05

GENERAL TOLERANCE				DWG NO.		APPD:	WIND	Scale	1:1
X.±0.45		x.°±5°		Title	1.5H MICRO SIM CARD 6P 单边带档	CHKD:		UNIT	mm
.X±0.35		.x.°±2°				DR:			
.XX±0.25		.xx°±1°		Part NO.	5001B-SIM150-132	Date	2014/04/29		
.XXX±0.15		.xxx°±0.5°			东莞市文章济美电子有限公司				
SHEET	1/1								

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